

HiRel RadHard Power-MOS

- Low R_{DS(on)}
- Total Ionisation Dose (TID) hardened 100 kRad (Level R)
- Hermetically sealed
- N-channel
- CC Detail Spec. No.: 5205/026

Туре	Marking	Pin Configuration			Package	
		1	2	3	-	
BUY25CS12J-01	-	D	G	S	-	SMD05

Maximum Ratings

Parameter	Symbol	Values	Unit
Drain Source Voltage	V _{DS}	250	V
Gate Source Voltage	V _{GS}	+/- 20	V
Drain Gate Voltage	V_{DG}	250	V
Continuous Drain Current $T_c = 25 \text{ °C}$ $T_c = 100 \text{ °C}$	I _D	12.4 8	A
Continuous Source Current	I _S	12.4	А
Drain Current Pulsed, t_p limited by T_{jmax}	I _{DM}	50	Apk
Total Power Dissipation ¹⁾	P _{tot}	75	W
Operating and Storage Temperature	T _{op}	-55 to + 150	°C
Avalanche Energy	E _{AS}	60	mJ

Thermal Characteristics

Thermal Resistance (Junction to Case)	R _{th JC}	1.66	K/W
Soldering Temperature	T _{sol}	250	°C

Notes.:

1) For $T_S \le 25^{\circ}$ C. For $T_S > 25^{\circ}$ C derating is required.

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Flectrical Characteristics, at T₄=25°C² unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics					•
Breakdown Voltage Drain to Source $I_D = 0.25$ mA, $V_{GS} = 0$ V	B _{VDSS}	250	-	-	V
Gate Threshold Voltage $I_D = 1.0mA, V_{DS} \ge V_{GS}$	V _{GS(th)}	2.0	-	4.0	V
Gate to Source Leakage Current $V_{DS} = 0V, V_{GS} = +/-20V$	I _{GSS}	-	-	+/-100	nA
Drain Current $V_{DS} = 200V, V_{GS} = 0V$	I _{DSS}	-	-	25	μA
Drain Source On Resistance ¹⁾ $V_{GS} = 10V, I_D = 8A$	r _{DS(ON)}	-	-	0.13	Ω
Source Drain Diode, Forward Voltage $^{1),2)}$ V_{GS} = 0V, I_{S} = 12.4A	V _{SD}	-	-	1.2	V
AC Characteristics					
Turn-on Delay Time $V_{DD} = 50\% V_{DS}, I_D = 8A, R_G = 4.7\Omega$	t _{d(ON)}	-	14	25	ns
Rise Time V_{DD} = 50% V_{DS} , I_D = 8A, R_G = 4.7 Ω	t _r	-	7	25	ns
Turn-off Delay Time V_{DD} = 50% V_{DS} , I_D = 8A, R_G = 4.7 Ω	t _{d(OFF)}	-	25	35	ns
Fall Time V_{DD} = 50% V_{DS} , I_D = 8A, R_G = 4.7 Ω	t _f	-	5	20	ns
Reverse Recovery Time $V_{DD} < 50\% V_{DS}, I_D = 12.4A$	t _{rr}	-	300	400	ns
Common Source Input Capacitance $V_{DS} = 100V, V_{GS} = 0V, f = 1.0MHz$	C _{iss}	1300	-	1900	pF
Common Source Output Capacitance $V_{DS} = 100V, V_{GS} = 0V, f = 1.0MHz$	C _{oss}	90	-	150	pF
Common Source Reverse Transfer Capacitance $V_{DS} = 100V, V_{GS} = 0V, f = 1.0MHz$	C _{rss}	1	-	6	pF
Total Gate Charge $V_{DD} = 50\% V_{DS}, V_{GS} = 10V, I_D = 12.4A$	Q _G	-	25	42	nC

Notes.: 1) Pulsed Measurement: Pulse Width < 300µs, Duty Cycle <2.0%. 2) Measured within 2.0 mm of case.



Electrical Characteristics

at T_A=125°C; unless otherwise specified

Parameter	Symbol	Values		Unit	
		min.	max.		
DC Characteristics					
Gate Threshold Voltage $I_D = 1.0 \text{mA}, V_{DS} \ge V_{GS}$	$V_{GS(th)}$	1.5	-	V	
Gate to Source Leakage Current $V_{DS} = 0V, V_{GS} = +/-20V$	I _{GSS}	-	+/-200	nA	
Drain Current $V_{DS} = 200V, V_{GS} = 0V$	I _{DSS}	-	250	μΑ	
Drain Source On Resistance ¹⁾ $V_{GS} = 10V, I_D = 8A$	r _{DS(ON)}	-	0.3	Ω	

Notes.: 1) Pulsed Measurement: Pulse Width < 300µs, Duty Cycle <2.0%.

Electrical Characteristics

at T_A=-55°C; unless otherwise specified

Parameter	Symbol	Values		Unit		
		min.	max.			
DC Characteristics						
Gate Threshold Voltage $I_D = 1.0 \text{mA}, V_{DS} \ge V_{GS}$	$V_{GS(th)}$	-	5.0	V		



1 Safe operating area







t_pulse_rec [sec]



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3 Typ. output characteristics

 $I_D = f(V_{DS}); T_j = 25 \ ^{\circ}C$ parameter: V_{GS}



5 Typ. drain-source on-state resistance





4 Typ. output characteristics

 $I_D = f(V_{DS}); T_j = 150 \text{ °C}$ parameter: V_G



6 Typ. drain-source on-state resistance

 $\begin{array}{l} \mathsf{R}_{\mathsf{DS}(\mathsf{on})} = \mathsf{f}(\mathsf{T}_j) \\ \mathsf{I}_\mathsf{D} = 8\mathsf{A} \end{array}$



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7 Typ. transfer characteristics

 $I_{D} = f(V_{GS}); |VDS| > 2 |I_{D}| R_{DS(on)max}$ parameter: T_{i}



9 Typ. forward characteristics of reverse diode

I_F = f(V_{SD}) parameter: T_i



8 Typ. gate threshold voltage

$$I_D = f(T_j)$$

 $I_D = 1mA$



10 Typ. drain-source breakdown voltage

 $BV_{DSS} = f(T_j)$ $I_D = 250 \mu A$





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11 Typ. capacitances

$$C = f(V_{DS}); V_{GS} = 0 V; f = 1 MHz$$



12 Typ. gate charge

 $V_{GS} = f(Q_{gate}); ID = 12.4 A pulsed parameter: V_{DD}$





SMD05 Package



Edition 2016-09 Published by Infineon Technologies AG 85579 Neubiberg, Germany © Infineon Technologies AG 2016 All Rights Reserved.

Dimensions are typical [mm]

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